



RE933-08

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for TSSOP 38
- Pitch: 0.50 mm (173 mil)
- Hole diameter 1.00 mm
- Size 23.50 x 28.57 mm

Module-No.	Pitch	mil	Pin	Size (mm)
RE933-08	0.500 mm	19.6	38	6.100 (240 mil)